



WiPDA-Asia 2020 Japan

IEEE Workshop

on Wide Bandgap Power Devices
and Applications in Asia

September 23-25, 2020 Kyoto University of Advanced Science, Japan

Dear Representative:

The Workshop on Wide Bandgap Power Devices and Applications in Asia (WiPDA-Asia) is sponsored by IEEE Power Electronic Society, providing a forum for device scientists, circuit designers, and application engineers to share technology updates, research findings, development experience, and application knowledge. The 2020 WiPDA-Asia will be held in Kyoto, Japan, hosted by Kyoto University of Advanced Science.

In this new era of uncertainty with respect to large gatherings, WiPDA-Asia is one of the first IEEE conferences to offer a hybrid conference experience between the in-person attendees and those that are not able to travel to the workshop due to potential continuing coronavirus (COVID-19) imposed restrictions. As such, we are modifying our sponsorship structure and adding virtual booth and virtual attendee options for your organization. This will enable you to have a presence at this important meeting through the workshop's virtual exhibit available on the workshop website. Furthermore, the organizing committee is making provisions in the actual workshop schedule to have pre-recorded informative sponsor content pertaining to wide bandgap technologies to be played during the workshop to maximize views by both virtual and in-person attendees! These pre-recorded spots must strictly adhere to the times that will be allotted, but this is an unprecedented option being piloted by WiPDA-Asia. Guidelines are being developed to share with you in this regard.

Topics that will be covered are listed below:

- Hetero-epitaxial and bulk materials growth
- Gate dielectrics and surface passivation
- Device structures and fabrication techniques
- Device characterization and modeling
- Very high efficiency and compact converters
- SOAs including short-circuit, spike,
- Packaging, power modules, and ICs
- Hard-switched and soft-switched applications
- Common-mode and EMI management
- Gate drive and other auxiliary circuits
- High-performance passive components
- Applications in renewable energy

and transient tolerance

and storage, transportation,
industrial drives, and grid power

- Harsh environment (e.g. high temperature) operation and reliability

We need your assistance and enthusiasm to make this a successful conference. Please see the attached form to know how you can help contribute to the conference and our community. If you have any questions regarding on sponsorship, please do not hesitate to contact me at funaki@eei.eng.osaka-u.ac.jp.

Best regards,

Prof. Tsuyoshi Funaki

Osaka University

WiPDA-Asia 2020 General Chair

This is a great opportunity to present your company on a world stage, our sponsorship categories are as follows:

Sponsorship:

	Price	Booth	Free Participant	Exposure	Advertising
Diamond Sponsor (Max2)	US\$ 5,000 or JPYen 500,000	1	3	Company Logo on Web and Conference site, program booklet.	One A4 page in program book front or reverse side of back cover
Gold Sponsor (Max3)	US\$ 3,000 or JPYen 300,000	1	2	Company Logo on Web and Conference site, program booklet.	One A4 page inside program booklet
Silver Sponsor (Max5)	US\$ 2,000 or JPYen 200,000	1	1	Company Logo on Web and Conference site, program booklet.	
Bronze Sponsor (Max5)	US\$ 1,000 or JPYen 100,000	Virtual booth	1	Company Logo on Web and Conference site, program booklet.	
Virtual booth Sponsor	US\$ 500 or JPYen 50,000	Virtual booth	0	Company Logo on Web and Conference site, program booklet.	

Note: Each sponsorship level includes all the aspects of the lower level plus that highlighted in this table.

Payment Method:

Please contact our conference secretariat.

WiPDA-Asia 2020 Secretariat (treasurer) :

Takaaki Ibuchi

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Please submit your sponsorship application by Tuesday, June 30.

Sponsorship Application

Date:

Please check the sponsorship you wish to apply :			
<input type="checkbox"/> Diamond Sponsor	<input type="checkbox"/> US\$_5,000_	or	<input type="checkbox"/> JPYen_500,000_
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<input type="checkbox"/> Bronze Sponsor	<input type="checkbox"/> US\$_1,000_	or	<input type="checkbox"/> JPYen_100,000_
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Company Name			
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Thank you for your contribution towards WiPDA-Asia 2020